



SBR10U45SP5

10A SBR[®] SUPER BARRIER RECTIFIER POWERDI[®]

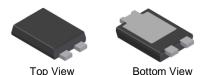
Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for +200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.093 grams (Approximate)

POWERDI®5



LEFT PIN O BOTTOMSIDE HEAT SINK

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

	_	
Part Number	Case	Packaging
SBR10U45SP5-13	POWERDI [®] 5	5,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information

POWERDI®5



S10U45S = Product Type Marking Code

Oli = Manufacturer's Code Marking

K = Factory Designator

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 15 for 2015)

WW = Week Code (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	V
RMS Reverse Voltage	V _{R(RMS)}	32	V
Average Rectified Output Current	lo	10	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	275	А
Repetitive Peak Avalanche Power (1µs, +25°C)	P _{ARM}	30,000	W

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Thermal Resistance Junction to Ambient (Note 5) Thermal Resistance Junction to Ambient (Note 6)		$R_{ hetaJA}$ $R_{ hetaJA}$	73 31	°C/W	
	V _R ≤ 80% V _{RRM}		-65 to +150		
Operating Temperature Range	V _R ≤ 50% V _{RRM}	T_J	≤180	°C	
	DC Forward Mode		≤200]	
Storage Temperature Range		T _{STG}	-65 to +175	°C	

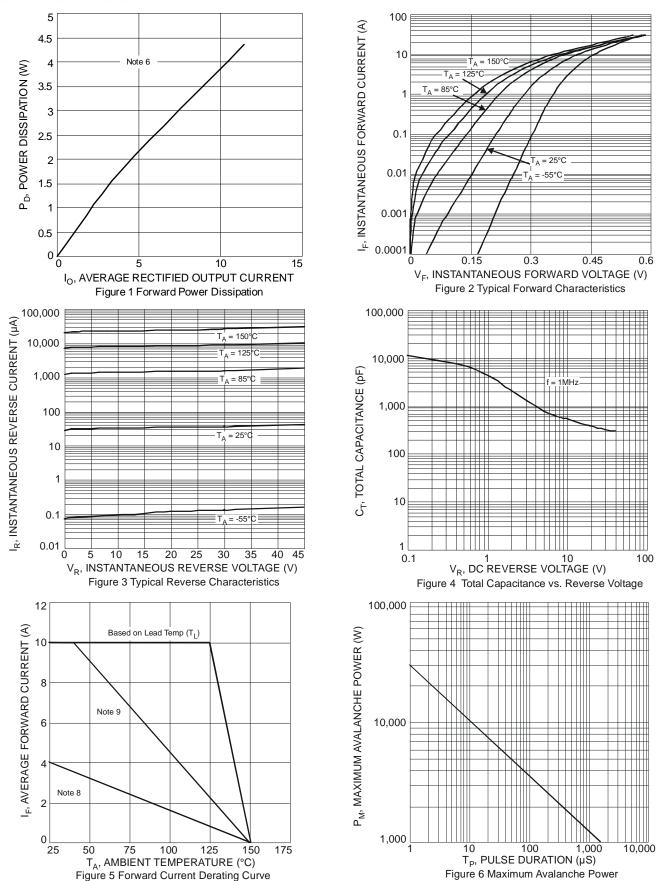
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	45	_	_	V	$I_R = 0.3 \text{mA}$
Forward Voltage Drop	V _F		 0.42 0.38	0.42 0.47 0.41	V	I _F = 8A, T _J = +25°C I _F = 10A, T _J = +25°C I _F = 10A, T _J = +125°C
Leakage Current (Note 7)	I _R	_ _ _	0.05 — 28.0	0.3 15 75	mA	$V_R = 45V, T_J = +25^{\circ}C$ $V_R = 45V, T_J = +100^{\circ}C$ $V_R = 45V, T_J = +150^{\circ}C$

Notes:

- 5. FR-4 PCB, 2oz. Copper. Minimum recommended pad layout per http://www.diodes.com.
 6. Polymide PCB, 2oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 14.4mm
 7. Short duration pulse test used to minimize self-heating effect.





Notes: 8. Device mounted on FR-4 substate, 2oz copper, with minimum recommended pad layout.

9. Device mounted on FR-4 substate, 2oz copper, with 10cm x 10cm pad layout.



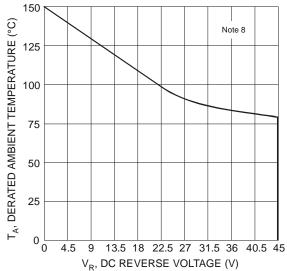
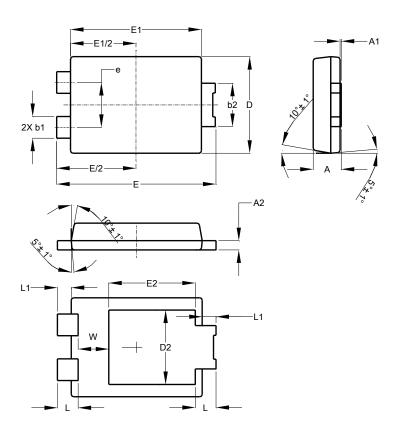


Figure 7 Operating Temperature Derating



Package Outline Dimensions

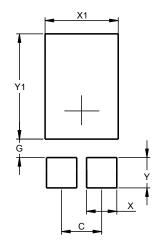
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI [®] 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2			3.054		
Е	6.40	6.60	6.504		
е			1.84		
E1	5.30	5.45	5.37		
E2			3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860



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